STATUS

PENDING

 \mathbf{X}

ABANDONED

DECLARATION FOR NON-PROVISIONAL PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below at 201 et seq. beneath my name.

I believe I am the original, first and sole inventor if only one name is listed at 201 below, or an original, first and joint inventor if plural names are listed at 201 et seq. below, of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD FOR PROVIDING A SMOOTH WAFER SURFACE

is attached hereto.which is identified by of which was filed on	locket No. 4717-6800 as Applicat	tion No.	·•		
I hereby state that I have reviewed amendment referred to above.	and understand the contents of the a	above identified application, includi	ng the claims, as	amended by any	
I acknowledge the duty to disclose i § 1.56.	nformation known to me to be mater	rial to patentability as defined in Title	e 37, Code of Fede	eral Regulations,	
I hereby claim foreign priority bene certificate listed below and have also the application on which priority is	efits under Title 35, United States Co o identified below any foreign applica claimed:	ode, § 119(a)-(d) of any foreign app ation for patent or inventor's certifica	olication(s) for pat ate having a filing d	ent or inventor's ate before that of	
EARLIEST FOREIGN A	PPLICATION(S), IF ANY, FILED	PRIOR TO THE FILING DATE OF	F THE APPLICA	TION	
APPLICATION NUMBER	COUNTRY	DATE OF FILING (day, month, year)	PRIORITY	RIORITY CLAIMED	
0209869	France	August 2, 2002	⊠ YES	□ NO	
			☐ YES	□ NO	
I hereby claim the benefit under Tit	le 35, United States Code, § 119(e)	of any United States provisional app	olication(s) listed	below.	
PROVISIONAL APPLICATION NUMBER		FILING DATE			
matter of each of the claims of this ap of Title 35, United States Code § 112	le 35, United States Code, § 120 of a pplication is not disclosed in the prio 2, I acknowledge the duty to disclose ns, § 1.56 which became available b	r United States application in the man	nner provided by the	ne first paragraph	

PATENTED

FILING DATE

May 5, 2003

international filing date of this application:

NON-PROVISIONAL

APPLICATION NO.

60/468,289

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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